HMC416* PRODUCT PAGE QUICK LINKS

Last Content Update: 02/23/2017

COMPARABLE PARTS \Box

View a parametric search of comparable parts.

EVALUATION KITS

• HMC416LP4 Evaluation Board

DOCUMENTATION

Application Notes

 Determining the FM Bandwidth of a Wideband Varactor Tuned VCO

Data Sheet

• HMC416 Data Sheet

REFERENCE MATERIALS \Box

Quality Documentation

- Package/Assembly Qualification Test Report: LP4, LP4B, LP4C, LP4K (QTR: 2013-00487 REV: 04)
- Package/Assembly Qualification Test Report: Plastic Encapsulated QFN (QTR: 05006 REV: 02)
- Semiconductor Qualification Test Report: GaAs HBT-A (QTR: 2013-00228)

DESIGN RESOURCES 🖵

- HMC416 Material Declaration
- PCN-PDN Information
- Quality And Reliability
- · Symbols and Footprints

DISCUSSIONS

View all HMC416 EngineerZone Discussions.

SAMPLE AND BUY 🖳

Visit the product page to see pricing options.

TECHNICAL SUPPORT 🖳

Submit a technical question or find your regional support number.

DOCUMENT FEEDBACK

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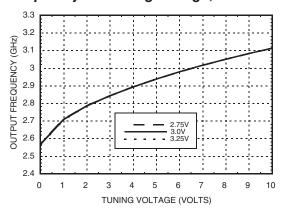


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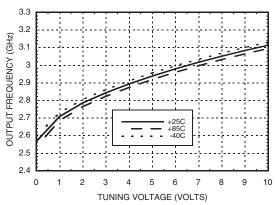


MMIC VCO w/ BUFFER AMPLIFIER, 2.75 - 3.0 GHz

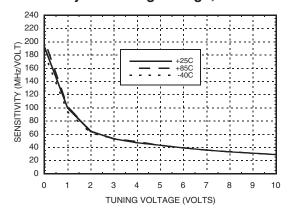
Frequency vs. Tuning Voltage, T= 25°C



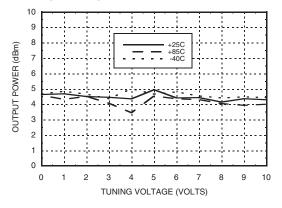
Frequency vs. Tuning Voltage, Vcc= +3V



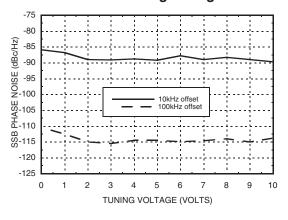
Sensitivity vs. Tuning Voltage, Vcc= +3V



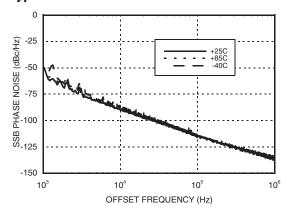
Output Power vs. Tuning Voltage, Vcc= +3V



Phase Noise vs. Tuning Voltage



Typical SSB Phase Noise @ Vtune= +5V



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MMIC VCO w/ BUFFER AMPLIFIER, 2.75 - 3.0 GHz

Absolute Maximum Ratings

Vcc	+3.5 Vdc
Vtune	0 to +11V
Channel Temperature	135 °C
Continuous Pdiss (T = 85°C) (derate 3.6 mW/°C above 85°C)	180 mW
Thermal Resistance (R _{TH}) (junction to package base)	277 °C/W
Storage Temperature	-65 to +150 °C
Operating Temperature	-40 to +85 °C

Typical Supply Current vs. Vcc

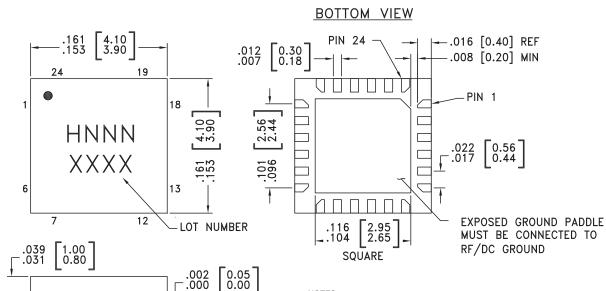
Vcc (V)	Icc (mA)
2.75	32
3.0	37
3.25	42

Note: VCO will operate over full voltage range shown above.



ELECTROSTATIC SENSITIVE DEVICE OBSERVE HANDLING PRECAUTIONS

Outline Drawing



NOTE

SEATING

PLANE

-C-

- 1. LEADFRAME MATERIAL: COPPER ALLOY
- 2. DIMENSIONS ARE IN INCHES [MILLIMETERS]
- 3. LEAD SPACING TOLERANCE IS NON-CUMULATIVE.
- 4. PAD BURR LENGTH SHALL BE 0.15mm MAXIMUM.
 PAD BURR HEIGHT SHALL BE 0.05mm MAXIMUM.
- 5. PACKAGE WARP SHALL NOT EXCEED 0.05mm.
- 6. ALL GROUND LEADS AND GROUND PADDLE MUST BE SOLDERED TO PCB RF GROUND.
- 7. REFER TO HITTITE APPLICATION NOT FOR SUGGESTED LAND PATTERN.

Package Information

.003[0.08]|C

Part Number	Package Body Material Lead Finish MS		MSL Rating	Package Marking [3]
HMC416LP4	Low Stress Injection Molded Plastic	Sn/Pb Solder	MSL1 [1]	H416 XXXX
HMC416LP4E	RoHS-compliant Low Stress Injection Molded Plastic	100% matte Sn	MSL1 [2]	H416 XXXX

- [1] Max peak reflow temperature of 235 °C
- [2] Max peak reflow temperature of 260 °C
- [3] 4-Digit lot number XXXX

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HMC416LP4 / 416LP4E

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MMIC VCO w/ BUFFER AMPLIFIER, 2.75 - 3.0 GHz

Pin Descriptions

Pin Number	Function	Description	Interface Schematic
1- 14, 17 - 19, 21, 23, 24	N/C	No Connection. These pins may be connected to RF ground. Performance will not be affected.	
15	GND	This pin must be connected to RF & DC ground.	→ GND =
16	RFOUT	RF output (AC coupled)	—
20	Vcc	Supply Voltage Vcc= 3V	Vcc O26pF
22	VTUNE	Control Voltage Input. Modulation port bandwidth dependent on drive source impedance.	10nH 50 \(\text{C};=\) 4.6pF \(\frac{1}{2} \) 3.2pF
	GND	Package bottom has an exposed metal paddle that must be RF & DC grounded.	○ GND =

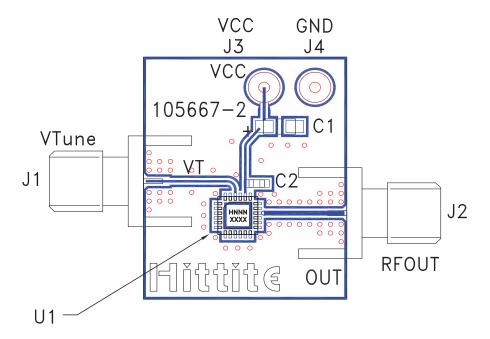


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Evaluation PCB



List of Materials for Evaluation PCB 105706 [1]

Item	Description
J1 - J2	PCB Mount SMA RF Connector
J3 - J4	DC Pin
C1	4.7 μF Tantalum Capacitor
C2	10,000 pF Capacitor, 0603 Pkg.
U1	HMC416LP4 / HMC416LP4E VCO
PCB [2]	105667 Eval Board

^[1] Reference this number when ordering complete evaluation PCB

The circuit board used in the final application should use RF circuit design techniques. Signal lines should have 50 ohm impedance while the package ground leads and exposed paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown is available from Hittite upon request.

^[2] Circuit Board Material: Rogers 4350



HMC416LP4 / 416LP4E

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Notes:

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